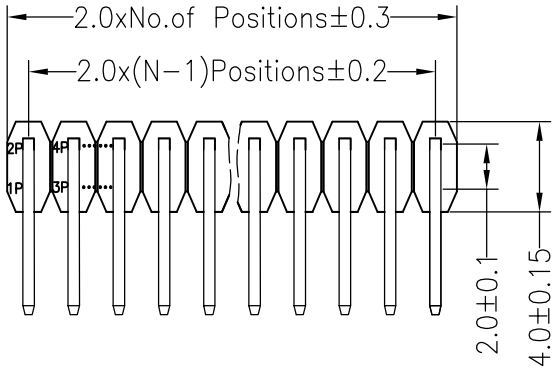
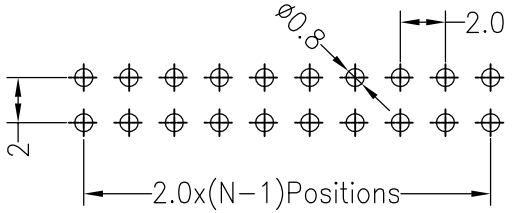
HSF RoHS FILE NO :E362810

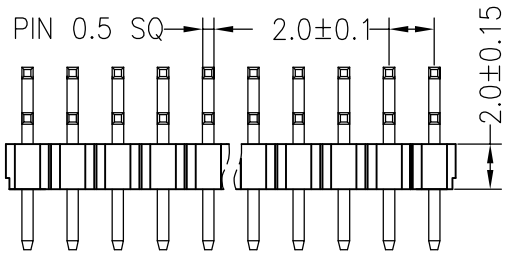
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

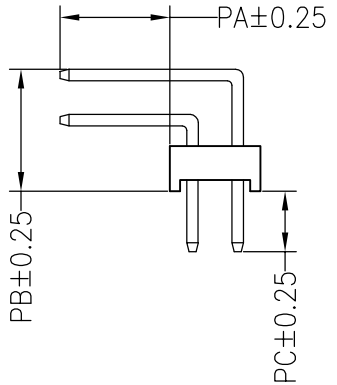
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1320 12 XX X N XX R XXX X 02

- XX — No.of Pins Per Row 2~40P
- X — Insulator Material Option
  - A=BK−PBT
  - C=BK−PA6T
  - D=BK−PA46
  - E=BK−PA9T
  - F=BK−LCP
- XX — Contact Plating
  - G0:Gold Flash
  - G1:1U" Gold
  - G2:1.5U" Gold
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- XXX — Pin Length
- X — Packing
  - A=Tray
  - T=Tube
  - 0=Pe
  - R=Tape&ReeL
  - P=Tube&ReeL

Dimension antitheses list					
ITEM	PA	PB	PC	L短	L长
Standard	4.00	5.40	2.80	10.50	14.50
Alternate					

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2019.09.18	NEW DRAWING	

OPERATION		DRAW	Liu Miao	19.09.18	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	132012XXXNXXRXXXX02
TITLE:	2.0PH 2xNpin H2.0mm 90°反弯